

DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention (Design, if applicable) entitled:

A STRUCTURE AND MANUFACTURING PROCESS OF A NANO DEVICE TRANSISTOR FOR A BIOSENSOR

the specification of which (check one):

☒ is attached hereto, or ☐ was filed on:

as U.S. Application Number or PCT

International Application Number:

and (if applicable) was amended on:

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in *Title 37, Code of Federal Regulations, §1.56*. I hereby claim foreign priority benefits under *Title 35, United States Code §119* of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

PRIOR FOREIGN APPLICATION(S)			PRIORITY CLAIMED	
Number	Country	Day/Month/Year Filed	Yes	N
092123497	TAIWAN	26/Aug./2003	✓	

☐ Additional Priority Application(s) Listed on Following Page(s)

I HEREBY CLAIM THE BENEFIT UNDER TITLE 35 U.S. CODE §119(E) OF ANY U.S. PROVISIONAL APPLICATIONS LISTED BELOW.

Application Number	Day/Month/Year Filed

☐ Additional Provisional Application(s) Listed on Following Page(s)

I hereby claim the benefit under *Title 35, United States Code, §120* of any United States application(s) or PCT international application(s) designating The United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of *Title 35, United States Code, §112*, I acknowledge the duty to disclose information which is material to patentability as defined in *Title 37, Code of Federal Regulations, §1.56* which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

Application Number	Filing Date	Status - Patented, Pending or Abandoned

☐ Additional US/PCT Priority Application(s) listed on Following Page(s)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under *section 1001 of title 18 of the United States Code* and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: I (We) hereby appoint as my (our) attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: J. Ernest Kenney, Reg. No. 19,179; Eugene Mar, Reg. No. 25,893; Richard E. Fichter, Reg. No. 26,382; Thomas J. Moore, Reg. No. 28,974; Joseph DeBenedictis, Reg. No. 28,502; Benjamin E. Urcia, Reg. No. 33,805; Chung C. Chen, Reg. No. 31,725; and

I(we) authorize my(our) attorneys to accept and follow instructions from _____ regarding any matter related to the preparation, examination, grant and maintenance of this application, any continuation, continuation-in-part or divisional based thereon, and any patent resulting therefrom, until I(we) or my(our) assigns withdraw this authorization in writing.

Send correspondence to: **BACON & THOMAS, PLLC**
625 Slaters Lane - 4th Floor
Alexandria, VA 22314-1176

Telephone Calls to:
(703) 683-0500

FULL NAME OF FIRST OR SOLE INVENTOR MING-JIUNN LAI	CITIZENSHIP TAIWAN
RESIDENCE ADDRESS No.59-2, Lane 243, Dongci St., Dongshih Township, Taichung County,423 Taiwan (R.O.C.)	POST OFFICE ADDRESS IS THE SAME AS RESIDENCE ADDRESS UNLESS OTHERWISE SHOWN BELOW
DATE 71/Nov./2003	SIGNATURE Ming-Jiunn Lai

☒ See following page(s) for additional joint inventors.

CONTINUATION OF DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY

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PRIOR FOREIGN APPLICATION(S) (35 USC § 119)			PRIORITY CLAIMED	
Number	Country	Day/M nth/Year Filed	Yes	No
092123497	TAIWAN	26/Aug./2003	✓	

PRIOR PROVISIONAL APPLICATIONS 35 U.S. CODE § 119(E)	
Application Number	Day/Month/Year Filed

PRIOR U.S. OR PCT INTERNATIONAL APPLICATIONS (35 U.S. CODE § 120)		
Application Number	Filing Date	Status - Patented, Pending or Abandoned

FULL NAME OF JOINT INVENTOR HUNG-HSIANG WANG	CITIZENSHIP TAIWAN
RESIDENCE ADDRESS 1F., No.21, Alley 48, Lane 179, Sec. 2, Neihu Rd., Neihu District, Taipei City, 114 Taiwan (R.O.C.),	POST OFFICE ADDRESS IS THE SAME AS RESIDENCE ADDRESS UNLESS OTHERWISE SHOWN BELOW
DATE 11/11 2003	SIGNATURE <i>Hung Hsiang Wang</i>

FULL NAME OF JOINT INVENTOR JENG-HUA WEI	CITIZENSHIP TAIWAN
RESIDENCE ADDRESS 3F., No.213, Longjiang Rd., Jhongshan District, Taipei City, 104 Taiwan (R.O.C.)	POST OFFICE ADDRESS IS THE SAME AS RESIDENCE ADDRESS UNLESS OTHERWISE SHOWN BELOW
DATE 11/11 2003	SIGNATURE <i>Jeng-Hua Wei</i>

FULL NAME OF JOINT INVENTOR HSIN-HUI CHEN	CITIZENSHIP TAIWAN
RESIDENCE ADDRESS No.20, Lane 237, Fongping 1st Rd., Daliao Township, Kaohsiung County, 831 Taiwan (R.O.C.)	POST OFFICE ADDRESS IS THE SAME AS RESIDENCE ADDRESS UNLESS OTHERWISE SHOWN BELOW
DATE 11/11 2003	SIGNATURE <i>Hsin-Hui Chen</i>

FULL NAME OF JOINT INVENTOR MING-JER KAO	CITIZENSHIP TAIWAN
RESIDENCE ADDRESS No.21, Alley 323, Lane 12, Sec. 2, Changhe St., Annan District, Tainan City, 709 Taiwan (R.O.C.)	POST OFFICE ADDRESS IS THE SAME AS RESIDENCE ADDRESS UNLESS OTHERWISE SHOWN BELOW
DATE 11/11 2003	SIGNATURE <i>Ming-Jer Kao</i>

☐ See following pages for additional joint inventors/priority applications.